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# ON Semiconductor®

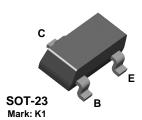
# To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to Fairchild <a href="guestions@onsemi.com">guestions@onsemi.com</a>.

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# **BCW71**



# **NPN General Purpose Amplifier**

This device is designed for general purpose amplifier applications at collector currents to 300 mA. Sourced from Process 10.

# **Absolute Maximum Ratings\***

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CEO}$	Collector-Emitter Voltage	45	V
V <sub>CES</sub>	Collector-Base Voltage	50	V
V <sub>EBO</sub>	Emitter-Base Voltage	5.0	V
Ic	Collector Current - Continuous	500	mA
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units	
		*BCW71		
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	350 2.8	mW mW/°C	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W	

<sup>\*</sup>Device mounted on FR-4 PCB 40 mm X 40 mm X 1.5 mm.

# **NPN General Purpose Amplifier**

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TA = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
OFF CHARACTERISTICS						
	Collector-Emitter Breakdown	I <sub>C</sub> = 1.0 mA, I <sub>B</sub> = 0	45	1	ı	
$V_{(BR)CEO}$	Voltage	IC = 1.0 MA, IB = 0	45			V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 10 \mu A, I_E = 0$	50			V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 10 \mu\text{A},  I_C = 0$	5.0			V
I <sub>CBO</sub>	Collector-Cutoff Current	$V_{CB} = 20 \text{ V}, I_{E} = 0$			100	μΑ
		$V_{CB} = 20 \text{ V}, I_{E} = 0, T_{A} = 100^{\circ}\text{C}$			10	

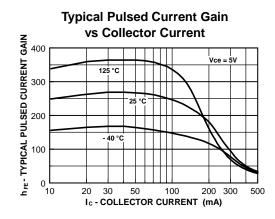
### **ON CHARACTERISTICS**

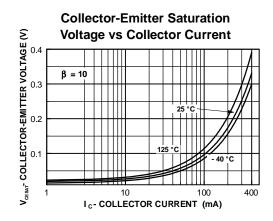
h <sub>FE</sub>	DC Current Gain	$I_C = 2.0 \text{ mA}, V_{CE} = 5.0 \text{ V}$	110		220	
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	$I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$			0.25	V
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	$I_C = 50 \text{ mA}, I_B = 2.5 \text{ mA}$		0.85		V
V <sub>BE(on)</sub>	Base-Emitter On Voltage	$I_C = 2.0 \text{ mA}, V_{CE} = 5.0 \text{ V}$	0.6		0.75	V

### SMALL SIGNAL CHARACTERISTICS

f <sub>T</sub>	Current Gain - Bandwidth Product	$I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V},$ f = 35  MHz	330		MHz
C <sub>obo</sub>	Output Capacitance	$V_{CE} = 10 \text{ V}, I_{E} = 0, f = 1.0 \text{ MHz}$		4.0	pF
C <sub>ibo</sub>	Input Capacitance	$V_{EB} = 0.5 \text{ V}, I_{C} = 0, f = 1.0 \text{ MHz}$	9.0		pF
NF	Noise Figure	$\begin{split} I_C &= 0.2 \text{ mA}, \text{ V}_{CE} = 5.0 \text{ V}, \\ R_S &= 2.0 \text{ k}\Omega, \text{ f} = 1.0 \text{ kHz}, \\ BW &= 200 \text{ Hz} \end{split}$		10	dB

# **Typical Characteristics**

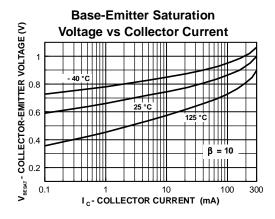


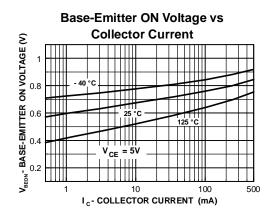


# **NPN General Purpose Amplifier**

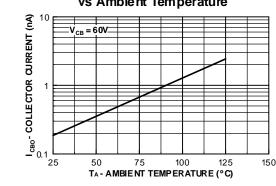
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# Typical Characteristics (continued)

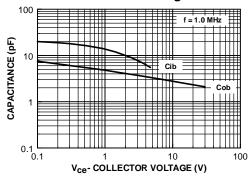




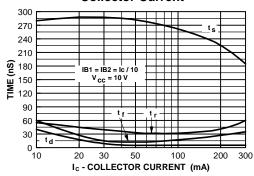
# Collector-Cutoff Current vs Ambient Temperature



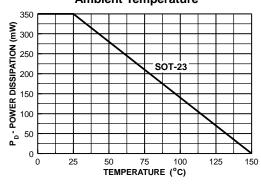
# Input and Output Capacitance vs Reverse Voltage



Switching Times vs Collector Current



Power Dissipation vs Ambient Temperature



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Datasheet Identification	Product Status	Definition
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Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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